

LM2682 Switched Capacitor Voltage Doubling Inverter

Check for Samples: [LM2682](#)

FEATURES

- Inverts Then Doubles Input Supply Voltage
- Small VSSOP Package and SOIC Package
- 90Ω Typical Output Impedance
- 94% Typical Power Efficiency at 10 mA

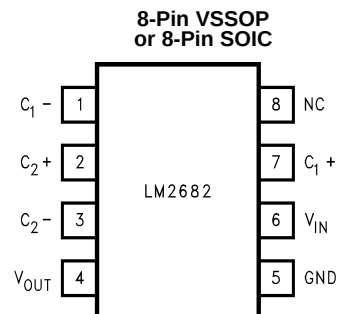
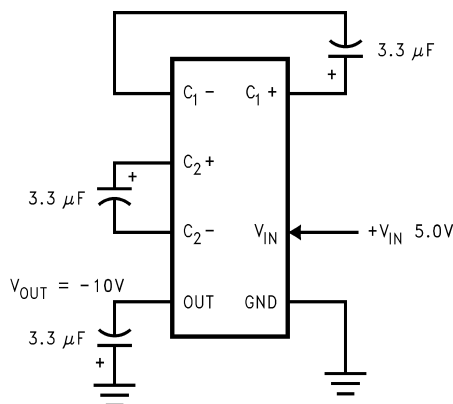
APPLICATIONS

- LCD Contrast Biasing
- GaAs Power Amplifier Biasing
- Interface Power Supplies
- Handheld Instrumentation
- Laptop Computers and PDAs

DESCRIPTION

The LM2682 is a CMOS charge-pump voltage inverter capable of converting positive voltage in the range of +2.0V to +5.5V to the corresponding doubled negative voltage of -4.0V to -11.0V respectively. The LM2682 uses three low cost capacitors to provide 10 mA of output current without the cost, size, and EMI related to inductor based circuits. With an operating current of only 150 μ A and an operating efficiency greater than 90% with most loads, the LM2682 provides ideal performance for battery powered systems. The LM2682 offers a switching frequency of 6 kHz.

Typical Operating Circuit and Pin Configuration



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.



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Absolute Maximum Ratings⁽¹⁾

Input Voltage (V_{IN})		+5.8V
V_{IN} dV/dT		1V/ μ sec
V_{OUT}		-11.6V
V_{OUT} Short-Circuit Duration		Continuous
Storage Temperature		-65°C to +150°C
Lead Temperature Soldering		+300°C
Power Dissipation ⁽²⁾	VSSOP	300 mW
	SOIC	470 mW
T_{JMAX}		+150°C

- (1) Absolute Maximum Ratings are those values beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics.
- (2) The maximum power dissipation must be de-rated at elevated temperatures (only needed for $T_A > 85^\circ\text{C}$) and is limited by T_{JMAX} (maximum junction temperature), θ_{JA} (junction to ambient thermal resistance) and T_A (ambient temperature). θ_{JA} is 140°C/W for the SOIC-8 package and 220°C/W for the VSSOP-8 package. The maximum power dissipation at any temperature is: $PD_{ISSMAX} = (T_{JMAX} - T_A)/\theta_{JA}$ up to the value listed in the Absolute Maximum Ratings.

Operating Ratings

ESD Susceptibility ⁽¹⁾	Human Body Model	2 kV
	Machine Model	200V
Ambient Temp. Range		-40°C to +85°C
Junction Temp. Range		-40°C to +125°C

- (1) The human body model is a 100 pF capacitor discharged through a 1.5 k Ω resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin.

LM2682

Electrical Characteristics

$V_{IN} = 5\text{V}$ and $C_1 = C_2 = C_3 = 3.3\mu\text{F}$ unless otherwise specified. Limits with **bold typeface** apply over the full operating ambient temperature range, -40°C to +85°C, limits with standard typeface apply for $T_A = 25^\circ\text{C}$.

Symbol	Parameter	Conditions	Min	Typical ⁽¹⁾	Max	Units
V_{IN}	Supply Voltage Range	$R_L = 2\text{ k}\Omega$	2.0		5.5	V
I_{IN}	Supply Current	Open Circuit, No Load		150	300 400	μA
R_{OUT}	V_{OUT} Source Resistance	$I_L = 10\text{ mA}$		90	150 200	Ω
		$I_L = 5\text{ mA}$, $V_{IN} = 2\text{ V}$		110	250	Ω
f_{OSC}	Oscillator Frequency	See ⁽²⁾		12	30	kHz
f_{SW}	Switching Frequency	See ⁽²⁾		6	15	kHz
η_{POWER}	Power Efficiency	$R_L = 2\text{ k}\Omega$ ⁽³⁾	90	93		%
$\eta_{VOLTAGE}$	Voltage Conversion Efficiency			99.9		%

- (1) Typical numbers are at 25°C and represent the most likely norm.
- (2) The output switches operate at one half of the oscillator frequency, $f_{OSC} = 2f_{SW}$.
- (3) The minimum specification is specified by design and is not tested.

Table 1. PIN DESCRIPTIONS

Pin Number	Symbol	Description
1	C_1^-	Capacitor C_1 negative terminal
2	C_2^+	Capacitor C_2 positive terminal
3	C_2^-	Capacitor C_2 negative terminal
4	V_{OUT}	Negative output voltage ($-2V_{IN}$)
5	GND	Device ground
6	V_{IN}	Power supply voltage
7	C_1^+	Capacitor C_1 positive terminal
8	NC	No Connection

Typical Performance Characteristics

$V_{IN} = 5V$ and $T_A = 25^\circ C$ unless otherwise noted.

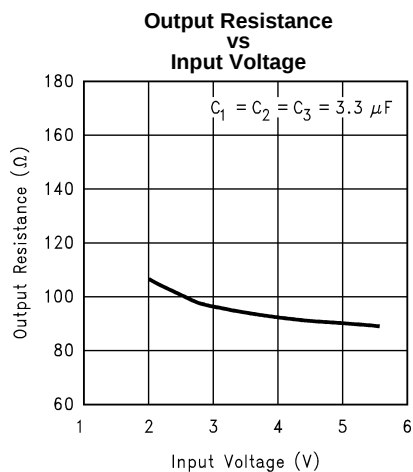


Figure 1.

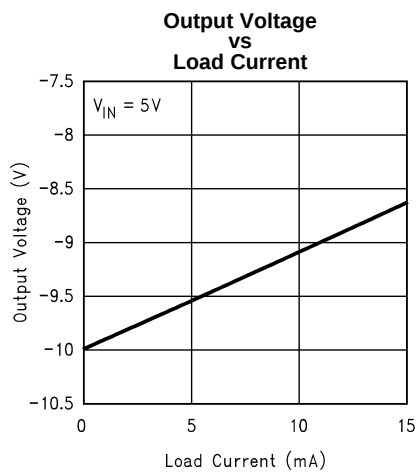


Figure 2.

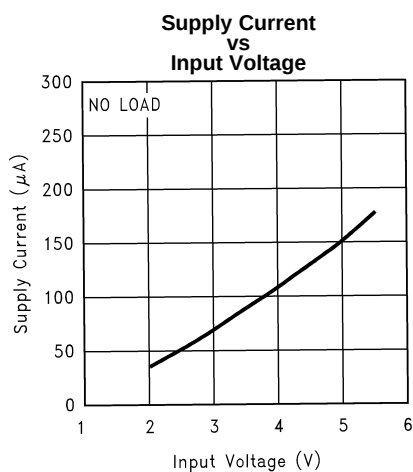


Figure 3.

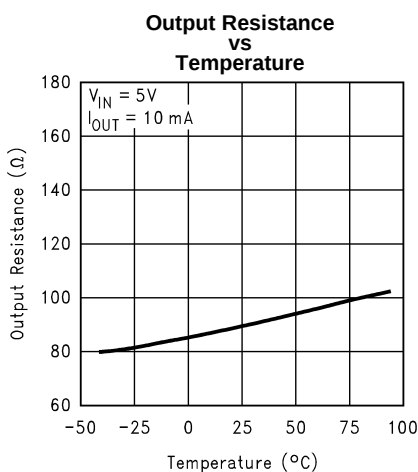


Figure 4.

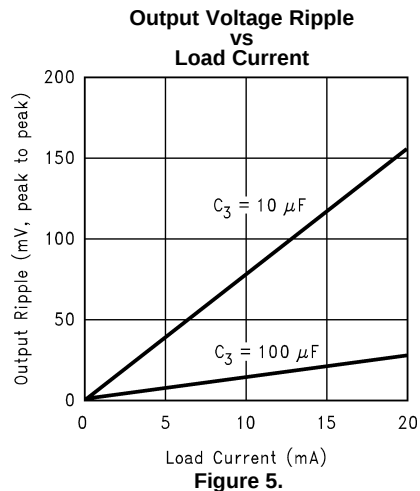


Figure 5.

BASIC APPLICATION CIRCUITS

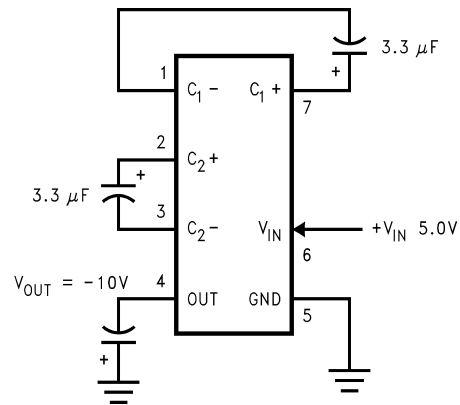


Figure 6. Doubling Voltage Inverter

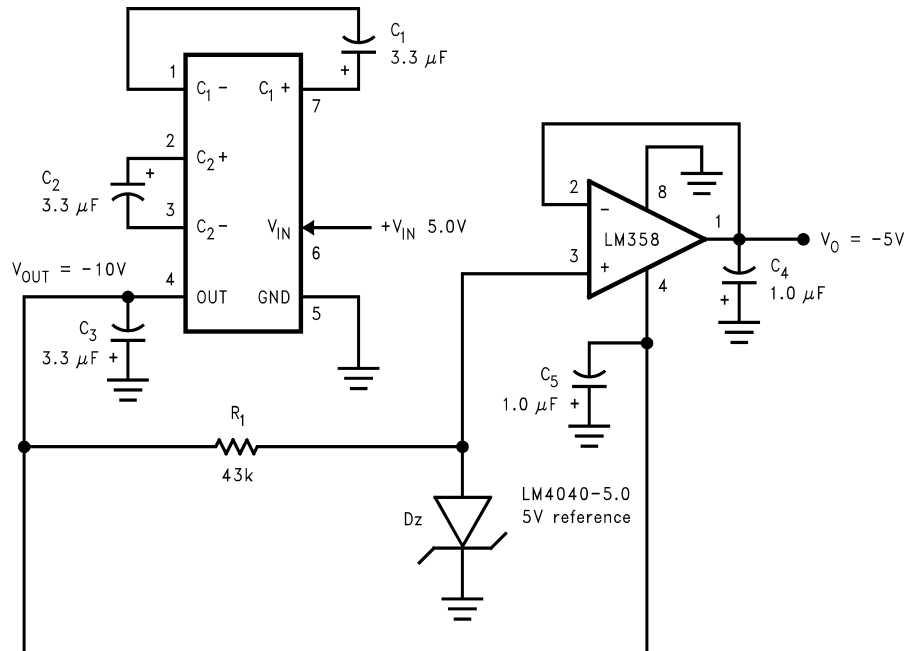


Figure 7. +5V to -5V Regulated Voltage Converter

APPLICATION INFORMATION

VOLTAGE DOUBLING INVERTER

The main application of the LM2682 is to generate a negative voltage that is twice the positive input voltage. This circuit requires only three external capacitors and is connected as shown in [Figure 6](#). It is important to keep in mind that the efficiency of the circuit is determined by the output resistance. A derivation of the output resistance is shown below:

$$R_{OUT} = 2(R_{SW1} + R_{SW2} + ESR_{C1} + R_{SW3} + R_{SW4} + ESR_{C2}) + 2(R_{SW1} + R_{SW2} + ESR_{C1} + R_{SW3} + R_{SW4} + ESR_{C2}) + 1/(f_{OSC} \times C1) + 1/(f_{OSC} \times C2) + ESR_{C3}$$

Using the assumption that all four switches have the same ON resistance our equation becomes:

$$R_{OUT} = 16R_{SW} + 4ESR_{C1} + 4ESR_{C2} + ESR_{C3} + 1/(f_{OSC} \times C1) + 1/(f_{OSC} \times C2)$$

Output resistance is typically 90Ω with an input voltage of +5V, an operating temperature of 25°C, and using low ESR 3.3 μF capacitors. This equation shows the importance of capacitor selection. Large value, low ESR capacitors will reduce the output resistance significantly but will also require a larger overall circuit. Smaller capacitors will take up less space but can lower efficiency greatly if the ESR is large. Also to be considered is that C1 must be rated at 6 VDC or greater while C2 and C3 must be rated at 12 VDC or greater.

The amount of output voltage ripple is determined by the output capacitor C3 and the output current as shown in this equation:

$$V_{RIPPLE\ P-P} = I_{OUT} \times (2 \times ESR_{C3} + 1/[2 \times (f_{OSC} \times C3)])$$

Once again a larger capacitor with smaller ESR will give better results.

+5V TO -5V REGULATED VOLTAGE CONVERTER

Another application in which the LM2682 can be used is for generating a -5V regulated supply from a +5V unregulated supply. This involves using an op-amp and a reference and is connected as shown in [Figure 7](#). The LM358 op-amp was chosen for its low cost and versatility and the LM4040-5.0 reference was chosen for its low bias current requirement. Of course other combinations may be used at the designer's discretion to fit accuracy, efficiency, and cost requirements. With this configuration the circuit is well regulated and is still capable of providing nearly 10 mA of output current. With a 9 mA load the circuit can typically maintain 5% regulation on the output voltage with the input varying anywhere from 4.5V to the maximum of 5.5V. With less load the results are even better. Voltage ripple concerns are reduced in this case since the ripple at the output of the LM2682 is reduced at the output by the PSRR of the op-amp used.

PARALLELING DEVICES

Any number of devices can be paralleled to reduce the output resistance. As shown in [Figure 8](#), each device must have its own pumping capacitors, C1 and C2, but only one shared output capacitor is required. The effective output resistance is the output resistance of one device divided by the number of devices used in parallel. Paralleling devices also gives the capability of increasing the maximum output current. The maximum output current now becomes the maximum output current for one device multiplied by the number of devices used in parallel. For example, if you parallel two devices you can get 20 mA of output current and have half the output resistance of one device supplying 10 mA.

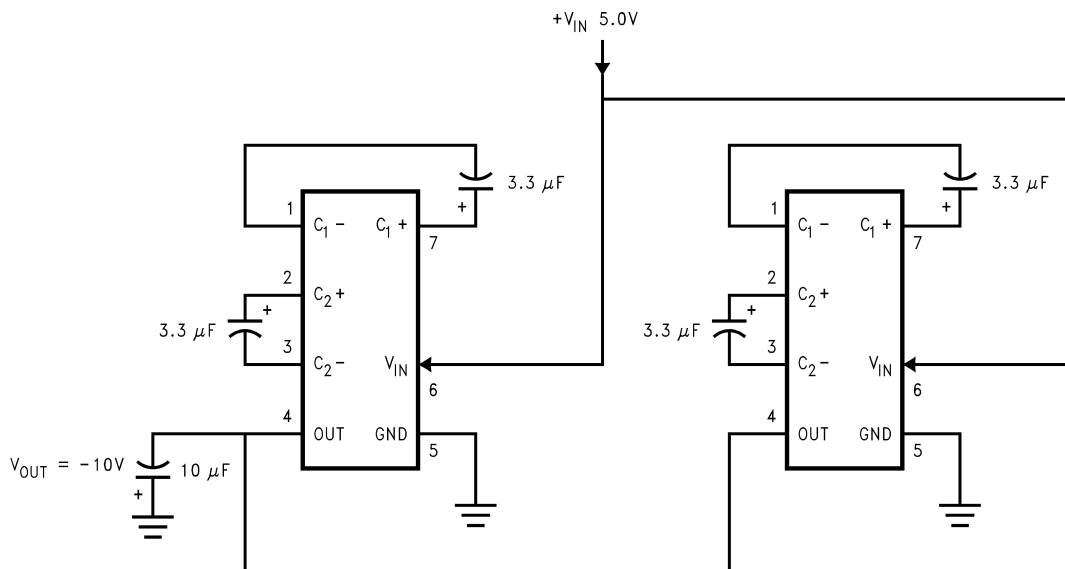


Figure 8. Paralleling Devices

REVISION HISTORY

Changes from Revision A (May 2013) to Revision B	Page
• Changed layout of National Data Sheet to TI format	7

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM2682MM/NOPB	Active	Production	VSSOP (DGK) 8	1000 SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	S11A
LM2682MM/NOPB.A	Active	Production	VSSOP (DGK) 8	1000 SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	S11A
LM2682MM/NOPB.B	Active	Production	VSSOP (DGK) 8	1000 SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	S11A
LM2682MMX/NOPB	Active	Production	VSSOP (DGK) 8	3500 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	S11A
LM2682MMX/NOPB.A	Active	Production	VSSOP (DGK) 8	3500 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	S11A
LM2682MMX/NOPB.B	Active	Production	VSSOP (DGK) 8	3500 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	S11A

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

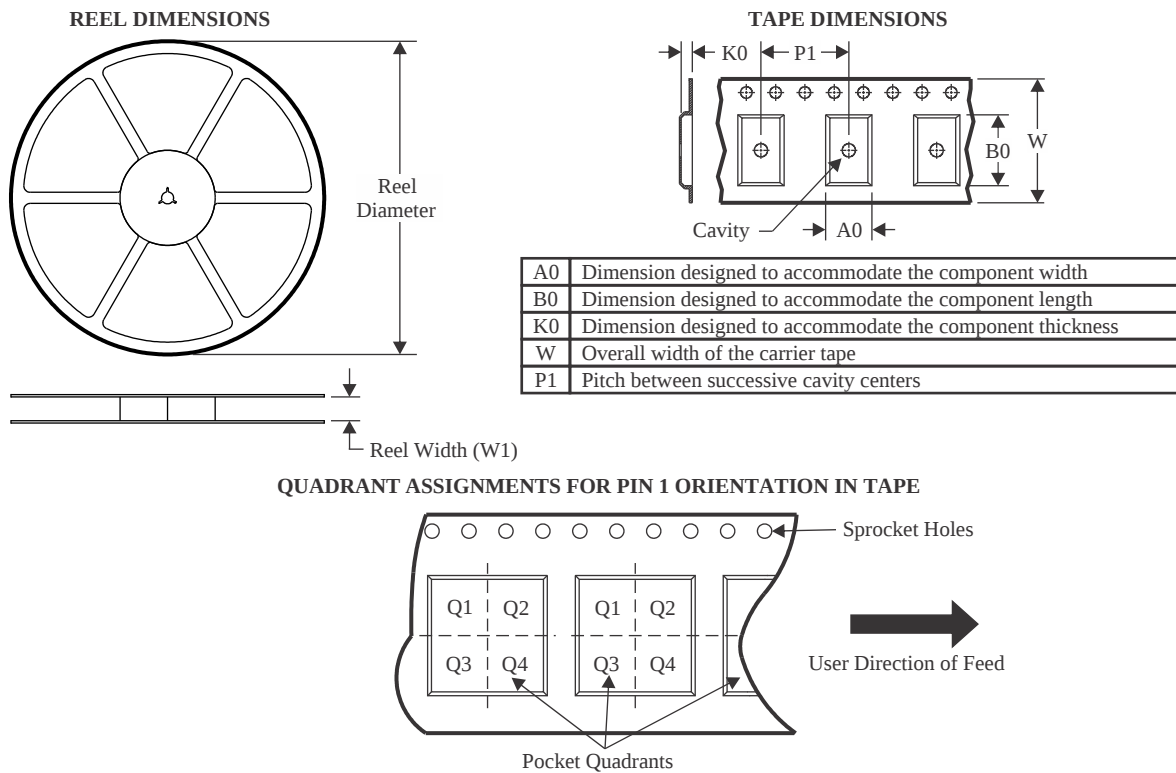
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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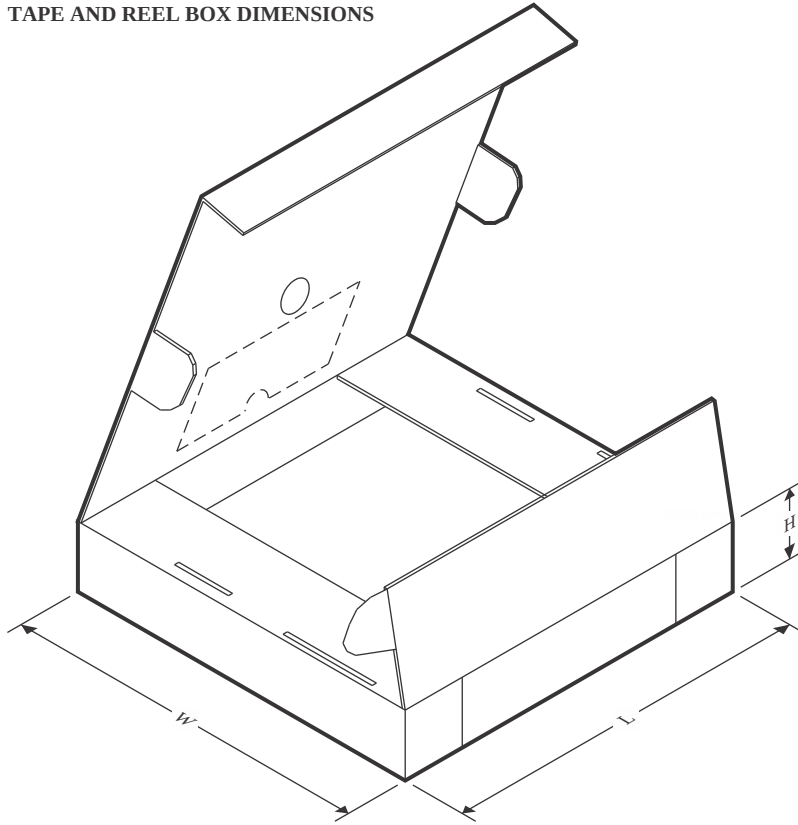
TAPE AND REEL INFORMATION



*All dimensions are nominal

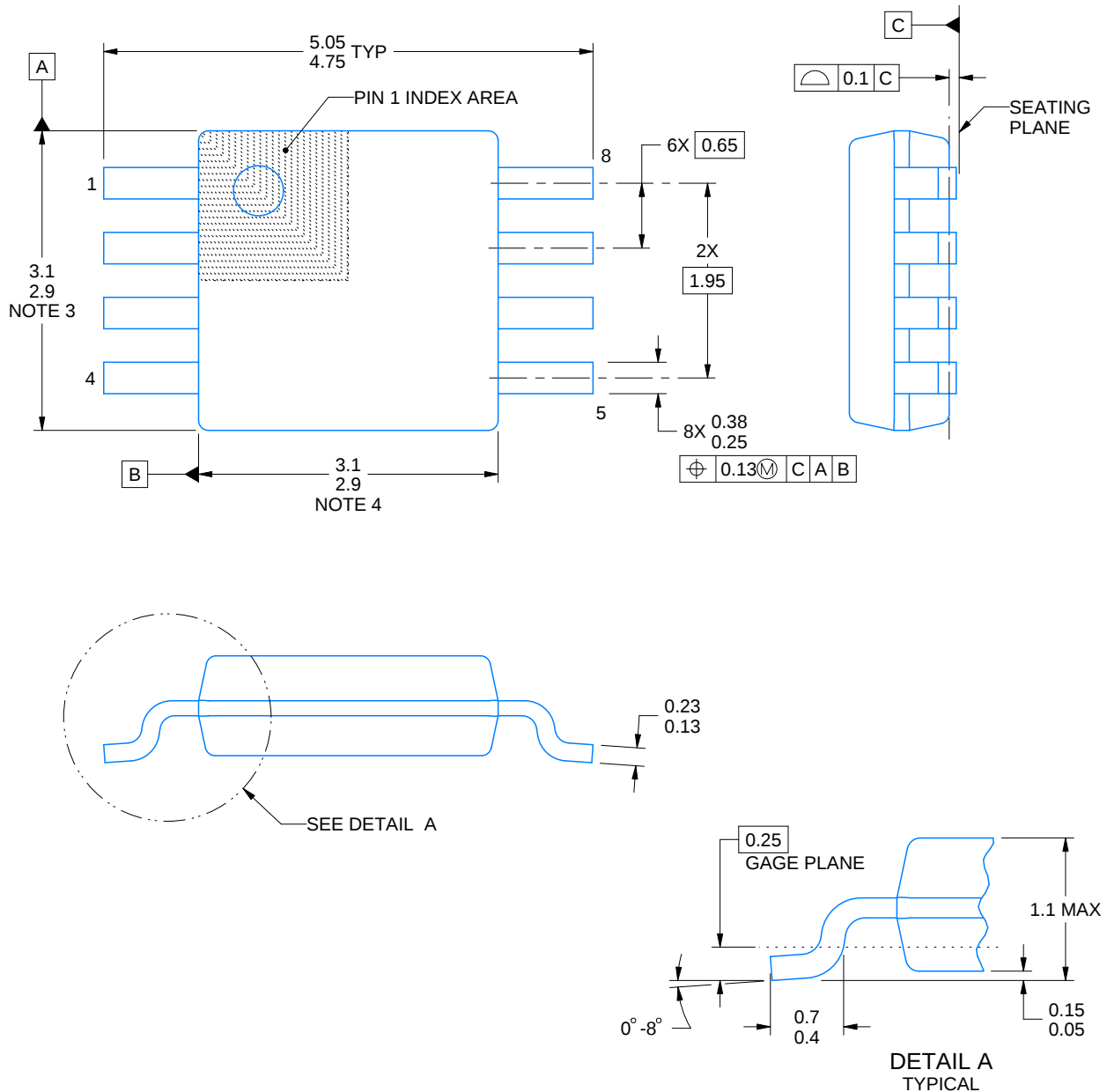
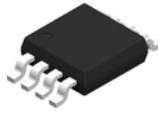
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2682MM/NOPB	VSSOP	DGK	8	1000	177.8	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2682MMX/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2682MM/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LM2682MMX/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0



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NOTES:

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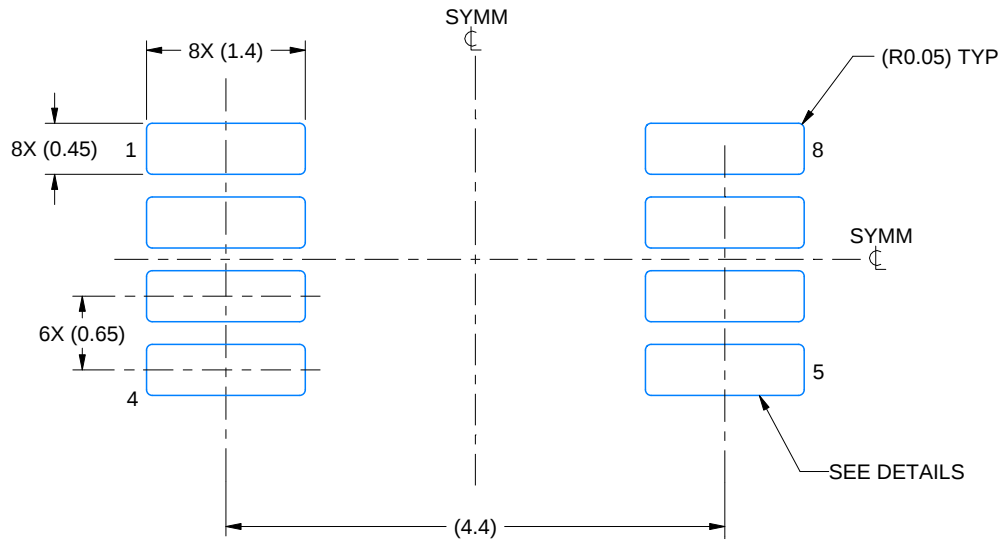
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-187.

EXAMPLE BOARD LAYOUT

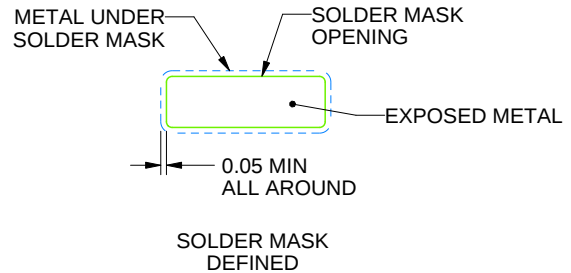
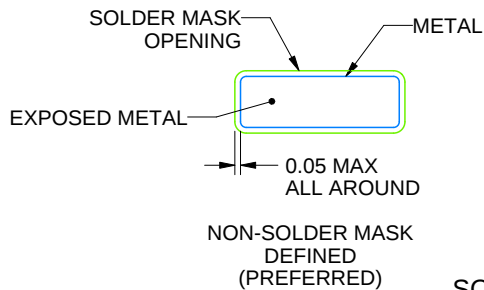
DGK0008A

™ VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 15X



SOLDER MASK DETAILS

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NOTES: (continued)

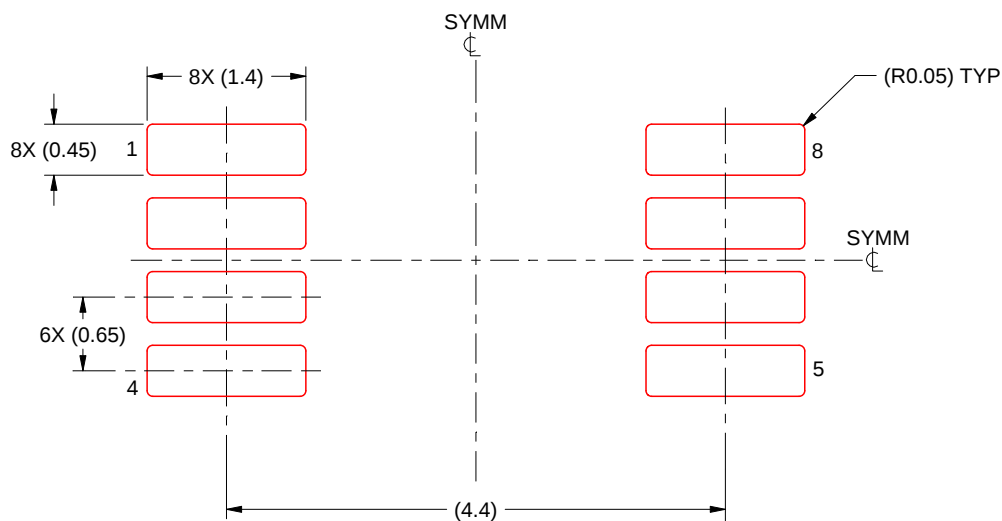
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
8. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.
9. Size of metal pad may vary due to creepage requirement.

EXAMPLE STENCIL DESIGN

DGK0008A

TM VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
SCALE: 15X

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NOTES: (continued)

11. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
12. Board assembly site may have different recommendations for stencil design.

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